



**AO6804**

**Common-Drain Dual N-Channel Enhancement Mode Field Effect Transistor**



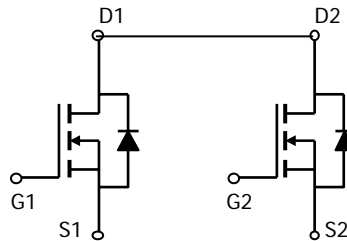
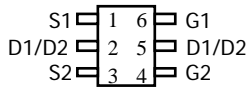
**General Description**

The AO6804 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. AO6804 is Pb-free (meets ROHS & Sony 259 specifications).

**Features**

$V_{DS} = 20V$   
 $I_D = 5.0A$  ( $V_{GS} = 4.5V$ )  
**Typical  $R_{ds}$**   
 $R_{DS(ON)} < 24m\Omega$  ( $V_{GS} = 4.5V$ )  
 $R_{DS(ON)} < 26m\Omega$  ( $V_{GS} = 4.0V$ )  
 $R_{DS(ON)} < 28m\Omega$  ( $V_{GS} = 3.1V$ )  
 $R_{DS(ON)} < 31m\Omega$  ( $V_{GS} = 2.5V$ )

**TSOP6  
Top View**



**Absolute Maximum Ratings  $T_A=25^\circ C$  unless otherwise noted**

| Parameter                              | Symbol         | 10 Sec           | Steady State | Units      |   |
|--|----------------|------------------|--------------|------------|---|
| Drain-Source Voltage                   | $V_{DS}$       | 20               |              | V          |   |
| Gate-Source Voltage                    | $V_{GS}$       | $\pm 12$         |              | V          |   |
| Continuous Drain Current <sup>A</sup>  | $I_D$          | $T_A=25^\circ C$ | 5            | 4          | A |
|  |                | $T_A=70^\circ C$ | 4            | 3.2        |   |
| Pulsed Drain Current <sup>B</sup>      | $I_{DM}$       | 25               |              |            |   |
| Power Dissipation <sup>A</sup>         | $P_D$          | $T_A=25^\circ C$ | 1.3          | 0.8        | W |
|  |                | $T_A=70^\circ C$ | 0.8          | 0.5        |   |
| Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 to 150       |              | $^\circ C$ |   |

**Thermal Characteristics**

| Parameter                                | Symbol          | Typ | Max | Units        |
|--|-----------------|-----|-----|--------------|
| Maximum Junction-to-Ambient <sup>A</sup> | $R_{\theta JA}$ | 76  | 95  | $^\circ C/W$ |
| $t \leq 10s$                             |                 |     |     |              |
| Maximum Junction-to-Ambient <sup>A</sup> | $R_{\theta JL}$ | 54  | 68  | $^\circ C/W$ |
| Steady State                             |                 |     |     |              |
| Maximum Junction-to-Lead <sup>C</sup>    |                 |     |     |              |

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Symbol                      | Parameter                             | Conditions  | Min      | Typ      | Max       | Units            |
|-----------------------------|---------------------------------------|---|----------|----------|-----------|------------------|
| <b>STATIC PARAMETERS</b>    |                                       |   |          |          |           |                  |
| $BV_{DSS}$                  | Drain-Source Breakdown Voltage        | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$                                  | 20       |          |           | V                |
| $I_{DSS}$                   | Zero Gate Voltage Drain Current       | $V_{DS} = 20\text{V}, V_{GS} = 0\text{V}$<br>$T_J = 55^\circ\text{C}$       |          |          | 1<br>5    | $\mu\text{A}$    |
| $I_{GSS}$                   | Gate-Body leakage current             | $V_{DS} = 0\text{V}, V_{GS} = \pm 12\text{V}$                               |          |          | $\pm 500$ | nA               |
| $V_{GS(th)}$                | Gate Threshold Voltage                | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$                                     | 0.5      | 0.75     | 1.2       | V                |
| $I_{D(ON)}$                 | On state drain current                | $V_{GS} = 4.5\text{V}, V_{DS} = 5\text{V}$                                  | 25       |          |           | A                |
| $R_{DS(ON)}$                | Static Drain-Source On-Resistance     | $V_{GS} = 4.5\text{V}, I_D = 5.0\text{A}$<br>$T_J = 125^\circ\text{C}$      | 18<br>25 | 24<br>33 | 32<br>43  | $\text{m}\Omega$ |
|                             |                                       | $V_{GS} = 4.0\text{V}, I_D = 4.5\text{A}$                                   | 22       | 26       | 34        |                  |
|                             |                                       | $V_{GS} = 3.1\text{V}, I_D = 4.5\text{A}$                                   | 21       | 28       | 37        | $\text{m}\Omega$ |
|                             |                                       | $V_{GS} = 2.5\text{V}, I_D = 4.0\text{A}$                                   | 22       | 31       | 42        | $\text{m}\Omega$ |
| $g_{FS}$                    | Forward Transconductance              | $V_{DS} = 5\text{V}, I_D = 5.0\text{A}$                                     |          | 7        |           | S                |
| $V_{SD}$                    | Diode Forward Voltage                 | $I_S = 1\text{A}, V_{GS} = 0\text{V}$                                       |          | 0.65     | 1         | V                |
| $I_S$                       | Maximum Body-Diode Continuous Current |   |          |          | 1.1       | A                |
| <b>DYNAMIC PARAMETERS</b>   |                                       |   |          |          |           |                  |
| $C_{iss}$                   | Input Capacitance                     | $V_{GS}=0\text{V}, V_{DS}=10\text{V}, f=1\text{MHz}$                        |          | 580      | 725       | pF               |
| $C_{oss}$                   | Output Capacitance                    |   |          | 95       |           | pF               |
| $C_{rss}$                   | Reverse Transfer Capacitance          |   |          | 70       |           | pF               |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$                         |          | 3.5      | 5.3       | $\Omega$         |
| <b>SWITCHING PARAMETERS</b> |                                       |   |          |          |           |                  |
| $Q_g$                       | Total Gate Charge                     | $V_{GS} = 4.5\text{V}, V_{DS} = 10\text{V}, I_D = 5\text{A}$                |          | 5.8      | 7.7       | nC               |
| $Q_{gs}$                    | Gate Source Charge                    |   |          | 1        |           | nC               |
| $Q_{gd}$                    | Gate Drain Charge                     |   |          | 1.6      |           | nC               |
| $t_{D(on)}$                 | Turn-On Delay Time                    | $V_{GS}=10\text{V}, V_{DS}=10\text{V}, R_L=2.0\Omega,$<br>$R_{GEN}=3\Omega$ |          | 2.4      |           | ns               |
| $t_r$                       | Turn-On Rise Time                     |   |          | 6.4      |           | ns               |
| $t_{D(off)}$                | Turn-Off Delay Time                   |   |          | 38       |           | ns               |
| $t_f$                       | Turn-Off Fall Time                    |   |          | 9.5      |           | ns               |
| $t_{rr}$                    | Body Diode Reverse Recovery Time      | $I_F=5\text{A}, dI/dt=100\text{A}/\mu\text{s}$                              |          | 18       | 24        | ns               |
| $Q_{rr}$                    | Body Diode Reverse Recovery Charge    | $I_F=5\text{A}, dI/dt=100\text{A}/\mu\text{s}$                              |          | 6        |           | nC               |

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ . In any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

D: The static characteristics in Figures 1 to 6 are obtained using  $< 300\mu\text{s}$  pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

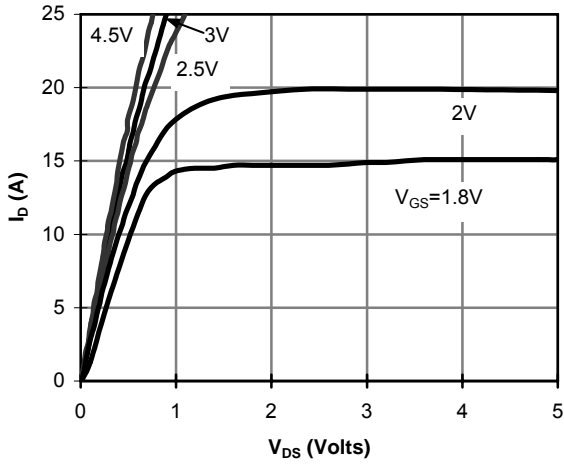


Figure 1: On-Region Characteristics

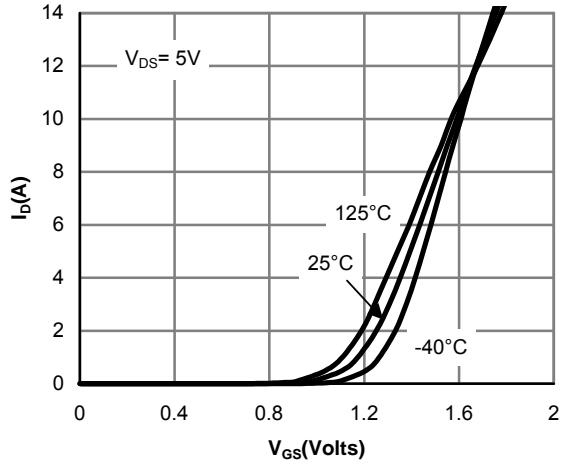


Figure 2: Transfer Characteristics

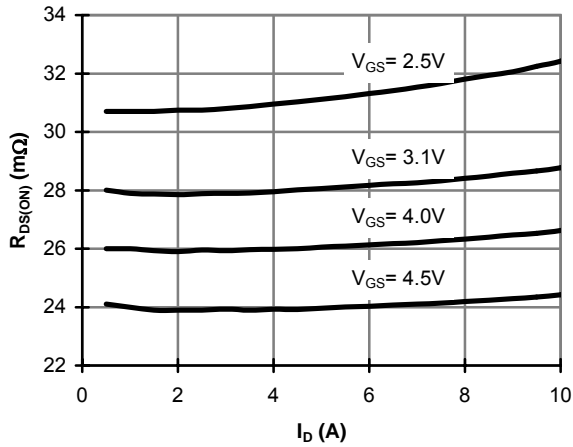


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

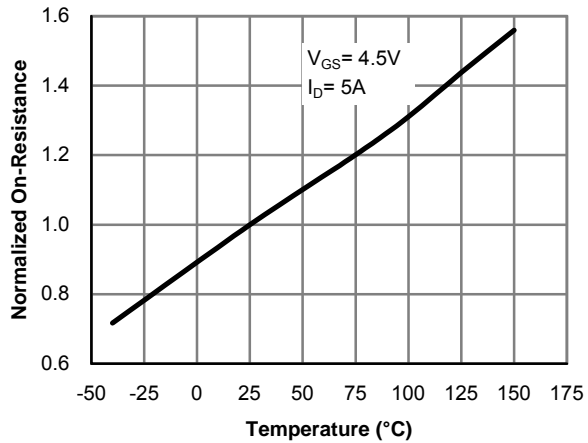


Figure 4: On-Resistance vs. Junction Temperature

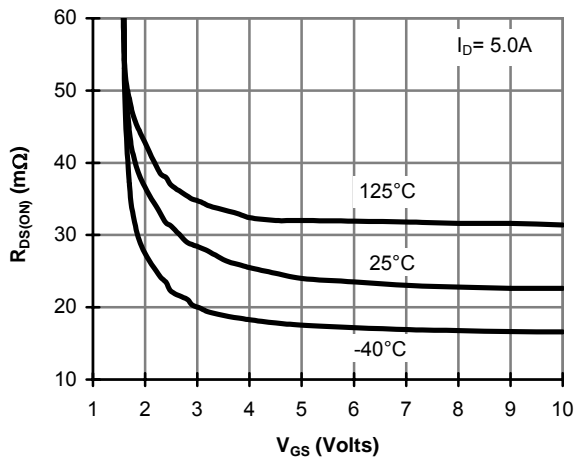


Figure 5: On-Resistance vs. Gate-Source Voltage

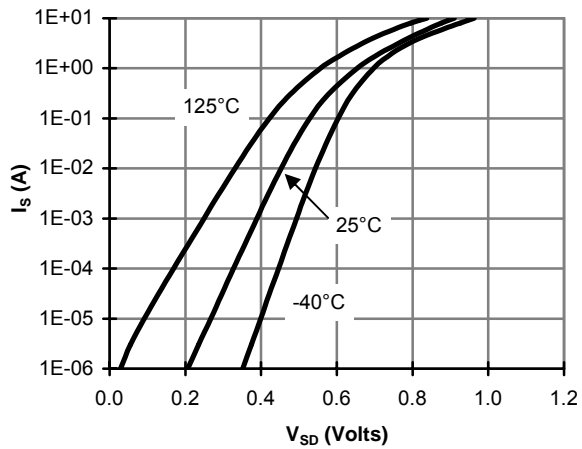


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

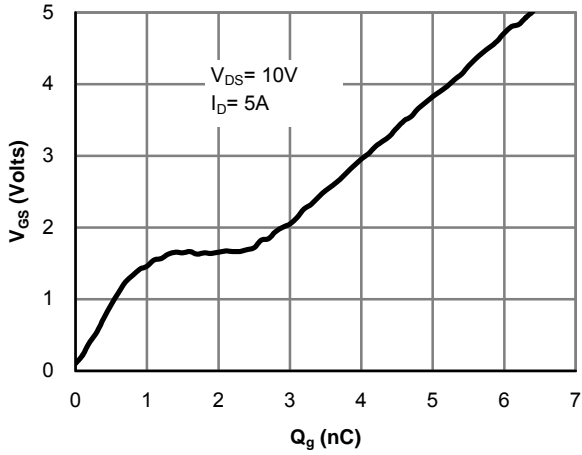


Figure 7: Gate-Charge Characteristics

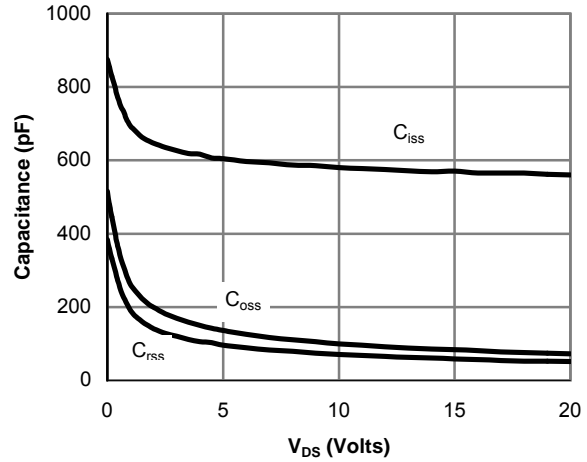


Figure 8: Capacitance Characteristics

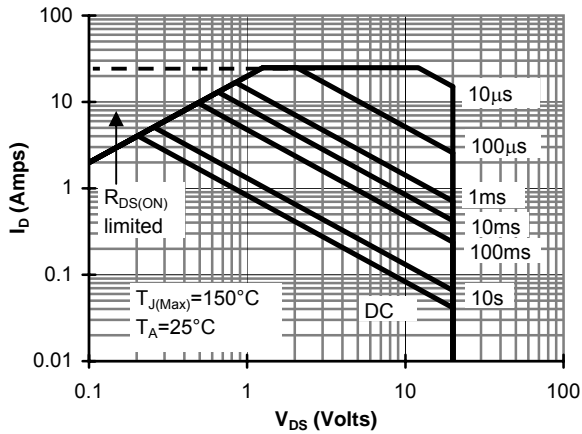


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

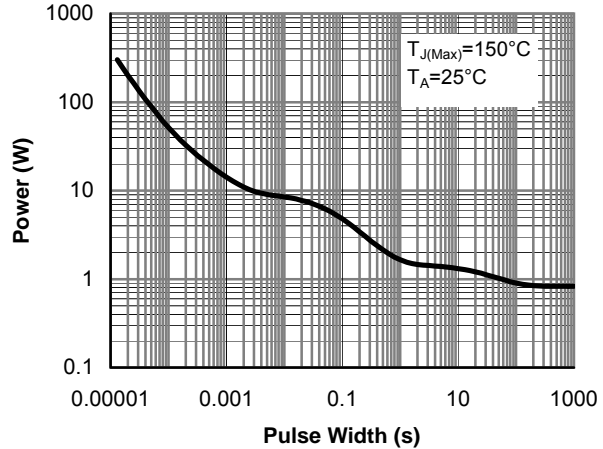


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

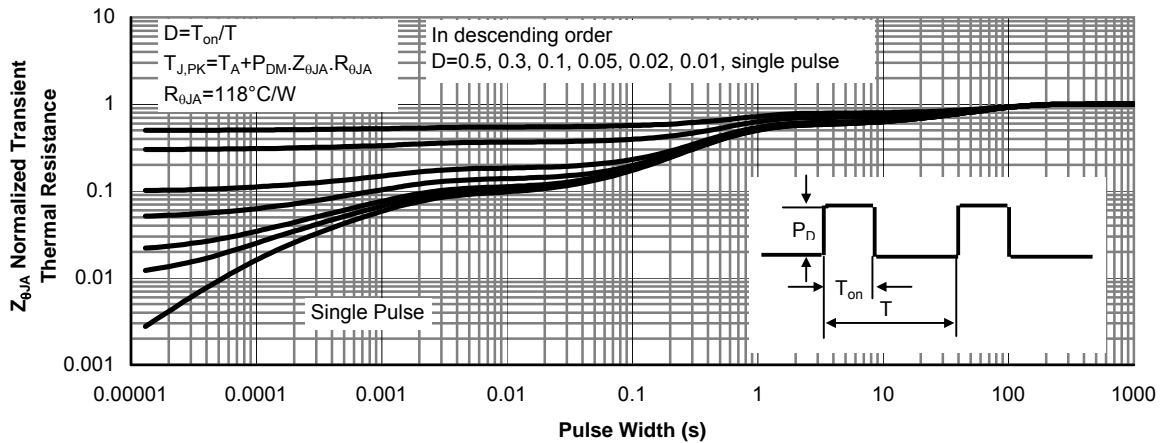


Figure 11: Normalized Maximum Transient Thermal Impedance (Note E)

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